

L Number	Hits	Search Text	DB	Time stamp
2	200	varisoft\$ same "222"	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:37
3	63156	cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:37
4	93	(varisoft\$ same "222") and (cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:20
6	7355	ammonium same oxalate	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:37
7	169975	urea	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:37
8	1478	(ammonium same oxalate) and urea	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:21
9	172	(cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)) and ((ammonium same oxalate) and urea)	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:21
10	5	(varisoft\$ same "222") and ((cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)) and ((ammonium same oxalate) and urea))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:26
11	93	(cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)) and ((varisoft\$ same "222") and (cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:26
12	5	((ammonium same oxalate) and urea) and ((cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)) and ((varisoft\$ same "222") and (cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers))))	USPAT; US-PGPUB; EPO; JPO; DERWENT	2004/05/12 10:36
13	5928	cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)	USOCR	2004/05/12 10:37
14	2552	ammonium same oxalate	USOCR	2004/05/12 10:37
15	28655	urea	USOCR	2004/05/12 10:37
16	1	varisoft\$ same "222"	USOCR	2004/05/12 10:38
17	21645	softener or softening same (agent or agents or compound or compounds)	USOCR	2004/05/12 10:38
18	90	(cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)) and (ammonium same oxalate)	USOCR	2004/05/12 10:39
19	37	urea and ((cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)) and (ammonium same oxalate))	USOCR	2004/05/12 10:39
20	10	(softener or softening same (agent or agents or compound or compounds)) and (urea and ((cationic same (polymer or copolymer or polymers or copolymers or resin or resins or homopolymer or homopolymers)) and (ammonium same oxalate)))	USOCR	2004/05/12 10:39

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USPAT US POPUL EPD JPD DERWENT

29 and 252/57.ccls.

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	U	I	Document ID	Issue Date	Pages	Title	Current Cit	Current XRef	Retrieval Cite	Inventor	S	C	P	3	A
1			US 20040038424 A1	20040226	31	Formaldehyde-ammonium salt complexes for the stabilization of bi	436/176	252/408.1; 422/61;		Maples, John A.					
2			US 20040028592 A1	20040212	12	Method for manufacturing highly-crystallized oxide powder	423/263	252/301.4R		Akimoto, Yuji et al.					
3			US 20030234184 A1	20031225	17	Method and composition for polishing a substrate	205/680	205/682; 205/685;		Liu, Feng Q. et al.					
4			US 20030089802 A1	20030515	14	Composition for resin-bonded magnet, and resin-bonded magnet	252/62.54			Yoshizawa, Shoichi et al.					
5			US 20030087525 A1	20030508	15	Slurry for use in polishing semiconductor device conductive s	438/691	252/79.1; 257/E21.304;		Sinha, Nishant et al.					
6			US 20020145127 A1	20021010	13	Chemical mechanical polishing slurry useful for copper substrates	252/79.1	257/E21.304		Kaufman, Vlasta Brusic et al.					
7			US 20020125461 A1	20020912	5	Ammonium oxalate-containing polishing system and method	252/79.1	252/79.5		Chou, Homer et al.					
8			US 20010006224 A1	20010705	10	Slurry for chemical mechanical polishing	252/79			Tsuchiya, Yasuaki et al.					
9			US 6641919 B1	20031104	8	Resin-bonded magnet	428/403	252/62.51R; 252/62.53;		Hayashi, Shinichi et al.					
10			US 6620037 B2	20030916	8	Chemical mechanical polishing slurry useful for copper substrates	451/559	106/3; 252/79.1;		Kaufman, Vlasta Brusic et al.					
11			US 6617170 B2	20030909	21	Method and device for collecting and stabilizing biological sample	436/176	252/408.1; 422/61;		Augello, Frank A. et al.					

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L9: (11117) ammonium adj (tartrate or oxalate) or ammonium same (tartrate or oxalate)
L10: (2491) 2 and 9
L11: (366) 3 and 10
L12: (71) 4 and 11
L13: (10) 8 and 12
L14: (10558) fabric same (softener or softening or conditioner)
L15: (11335) 2 and 3
L17: (2491) 2 and 9
L18: (366) 3 and 17
L19: (71) 14 and 18
L20: (10) 8 and 19
L21: (2475) ammonium adj (tartrate or oxalate)
L22: (510) 2 and 21
L23: (46) 3 and 22
L24: (4) 14 and 23
L25: (2) 8 and 24
L26: (1846) ammonium adj oxalate
L27: (374) 2 and 26
L28: (3264053) water or aqueous
L29: (351) 27 and 28
L30: (35) 29 and 30/57.ccls

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DBs: USPAT US POPUS EPO JPO DERWENT
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29 and 252/57.ccls.

	U	I	Document ID	Issue Date	Pages	Title	Current On	Current XRef	Retrieval Qas	Inventor	S	C	P	S	A
12	F		US 6602718 B1	20030805	11	Method and device for collecting and stabilizing a biological sample	436/176	252/408.1; 422/102;		Augello, Frank A. et al.					
13	F		US 6582623 B1	20030624	8	CMP composition containing silane modified abrasive particles	252/79.1	252/79.2; 252/79.3;		Grumbine, Steven K. et al.					
14	C	R	US 6569350 B2	20030527	14	Chemical mechanical polishing slurry useful for copper substrates	252/79.1	252/79.2; 252/79.3;		Kaufman, Vlasta Brusic et al.	R				
15	F		US 6551935 B1	20030422	17	Slurry for use in polishing semiconductor device conductive s	438/693	216/206; 216/89;		Sinha, Nishant et al.					
16	F		US 6435944 B1	20020820	6	CMP slurry for planarizing metals	451/41	106/3; 252/79.2;		Wang, Yuchun et al.					
17	F		US 6432828 B1	20020813	8	Chemical mechanical polishing slurry useful for copper substrates	438/693	106/3; 216/89;		Kaufman, Vlasta Brusic et al.					
18	F		US 6309560 B1	20011030	13	Chemical mechanical polishing slurry useful for copper substrates	252/79.1	252/79.4; 251/E21.304		Kaufman, Vlasta Brusic et al.					
19	F		US 6126853 A	20001003	11	Chemical mechanical polishing slurry useful for copper substrates	252/79.1	252/79.4; 251/E21.304		Kaufman, Vlasta Brusic et al.					
20	R		US 5954997 A	19990921	11	Chemical mechanical polishing slurry useful for copper substrates	252/79.1	252/79.2; 252/79.4;		Kaufman, Vlasta Brusic et al.					
21	F		US 5932144 A	19990803	28	Soluble aniline conducting polymers	252/500	252/518.1; 528/210;		Shimizu, Shigeru et al.					
22	F		US 5714092 A	19980203	8	Process for the production of hydrocarbonaceous monodisperse	252/373	252/372; 502/237		van Looy, Francine et al.					

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L9: (11117) ammonium adj (tartrate or oxalate) or ammonium same (tartrate or oxalate)
L10: (2491) 2 and 9
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L20: (10) 8 and 19
L21: (2475) ammonium adj (tartrate or oxalate)
L22: (510) 2 and 21
L23: (46) 3 and 22
L24: (4) 14 and 23
L25: (2) 8 and 24
L26: (1846) ammonium adj oxalate
L27: (374) 2 and 26
L28: (3264053) water or aqueous
L29: (351) 27 and 28
L30: (45) 29 and 252/57.ccls

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U	T	Document ID	Issue Date	Pages	Title	Current Or	Current XRef	Retrieval Class	Inventor	S	C	P	3
23	F	US 5700399 A	19971223	27	Soluble alkoxy-group substituted aminobenzenesulfonic acid aniline	252/500	174/68.1; 427/372.2;		Shimizu, Shigeru et al.				
24	F	US 5589108 A	19961231	27	Soluble alkoxy-group substituted aminobenzenesulfonic acid aniline	252/500	520/210; 520/214		Shimizu, Shigeru et al.				
25	F	US 5526224 A	19960611	14	Ion-conductive polymer electrolyte and electrolytic capacitor using the	361/523	252/62.2; 361/524;		Kanbara, Teruhisa et al.				
26	F	US 5244539 A	19930914	9	Composition and method for stripping films from printed circuit b	216/113	134/2; 134/3;		McGrath, Peter T. et al.				
27	F	US 5096642 A	19920317	6	Process for producing a high density ceramic of perovskite	264/661	252/62.9P; 501/102;		Shirasaki, Shin-ichi				
28	F	US 5002690 A	19910326	10	Production of stable liquid organic-powdered inorganic emulsi	252/182.14	252/182.15; 252/182.17;		Blount, David H.				
29	F	US 4839089 A	19890613	5	Substance for converting waste cooking oil into liquid soap	252/183.11	252/182.12; 252/182.32;		Shimizu, Kazuo				
30	F	US 4764357 A	19880816	4	Process for producing finely dMded powdery metal oxide compo	505/440	252/182.12; 420/901;		Sherif, Fawzy G. et al.				
31	F	US 4643984 A	19870217	24	Process for producing a composition which includes perovs	501/134	252/62.9P2; 423/594.9;		Abe, Kazunobu et al.				
32	F	US 4105572 A	19780808	18	Ferromagnetic toner containing water-soluble or water-solubilizabl	430/106.2	106/16; 252/301.21;		Gorondy, Emery J.				
33	F	US 3932296 A	19760113	6	Corrosion inhibitor	507/240	134/3; 15/111;		Byth, Nancy J.				

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L9: (11117) ammonium adj (tartrate or oxalate) or ammonium same (tartrate or oxalate)
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L22: (510) 2 and 21
L23: (46) 3 and 22
L24: (4) 14 and 23
L25: (2) 8 and 24
L26: (1846) ammonium adj oxalate
L27: (374) 2 and 26
L28: (3264053) water or aqueous
L29: (351) 27 and 28
L30: (35) 27 and 252/57.ccls

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DB: 1/2/FAT/US/POFUB/2/FQ/JFG/DERIVENT
Default operator: QN
29 and 252/57.ccls.

	U	I	Document ID	Issue Date	Pages	Title	Current OR	Current XRef	Retrieval Class	Inventor	S	C	P	3	4	5	6	7	8	9	0
26			US 5244539 A	19930914	9	Composition and method for stripping films from printed circuit boards	216/13	134/2; 134/3;		McGrath, Peter T. et al.											
27			US 5096642 A	19920317	6	Process for producing a high density ceramic of perovskite	264/66.1	252/62.9R; 501/102;		Shirasaki, Shin-ichi											
28			US 5002690 A	19910326	10	Production of stable liquid organic-powdered inorganic emulsions	252/182.14	252/182.15; 252/182.17;		Blount, David H.											
29			US 4839089 A	19890613	5	Substance for converting waste cooking oil into liquid soap	252/183.11	252/182.12; 252/182.32;		Shimizu, Kazuo											
30			US 4764357 A	19880816	4	Process for producing finely divided powdery metal oxide compounds	505/440	252/182.12; 420/901;		Sheriff, Fawzy G. et al.											
31			US 4643984 A	19870217	24	Process for producing a composition which includes perovskite	501/134	252/62.9PZ; 423/594.9;		Abe, Kazunobu et al.											
32			US 4105572 A	19780808	18	Ferromagnetic toner containing water-soluble or water-solubilizable	430/106.2	106/16; 252/301.21;		Gorondy, Emery J.											
33			US 3932296 A	19760113	6	Corrosion inhibitor	507/240	134/1; 134/11;		Bylth, Nancy J.											
34			US 3896043 A	19750722	9	Non-cyanide alkaline composition for dissolving non-ferrous metals	252/186.43	134/2; 216/100;		Fadgen, Jr., Earl J.											
35			US 3719604 A	19730306	3	PRESSURIZING GAS-PRODUCING CHARGES CONTAINING AN AMINO	252/186.33	149/19.8; 149/40;		Prior, Josef et al.											

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